

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT4211492

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
WEI MING	12/28/2016
XIAONONG ZHAN	12/28/2016
TAISUKE AKAHORI	12/26/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	KONICA MINOLTA LABORATORY U.S.A., INC.
<b>Street Address:</b>	2855 Campus Drive, Suite 100
<b>City:</b>	San Mateo
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	94403
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15394846
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(213)625-0691
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	213-625-5076
<b>Email:</b>	ychen@cyiplaw.com
<b>Correspondent Name:</b>	YING CHEN CHEN YOSHIMURA LLP
<b>Address Line 1:</b>	108 W 2ND STREET
<b>Address Line 2:</b>	#514
<b>Address Line 4:</b>	LOS ANGELES, CALIFORNIA 90012
<b>ATTORNEY DOCKET NUMBER:</b>	75675.1387
<b>NAME OF SUBMITTER:</b>	YING CHEN
<b>SIGNATURE:</b>	/Ying Chen/
<b>DATE SIGNED:</b>	01/05/2017
<b>Total Attachments: 2</b>	
source=BIL1387-assignment#page1.tif	
source=B1387-assignment_TA#page1.tif	



## ASSIGNMENT

WHEREAS I, the below named inventor (hereinafter referred to as Assignor(s)), have made an invention entitled:

### METHOD AND SYSTEM FOR CAPTURING IMAGES FOR WOUND ASSESSMENT WITH MOISTURE DETECTION

for which I executed an application for United States Letters Patent concurrently herewith; and

WHEREAS, **KONICA MINOLTA LABORATORY U.S.A., INC.**, a corporation of California whose post office address is 2855 Campus Drive, Suite 100, San Mateo, California 94403, U.S.A. (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I, as Assignor, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my entire right, title, and interest in and to this invention, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, as well as all rights to claim priority on the basis of this application, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment and the Proprietary Rights and Confidentiality Agreement;

AND, I HEREBY covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment.

AND, I HEREBY further covenant and agree that I will cooperate with Assignee, its lawful successors and assigns, or, in case that the rights in this Invention are further transferred from Assignee to an affiliate company, with the affiliate company in a manner consistent with existing and ongoing obligations under the Proprietary Rights and Confidentiality Agreement.

IN TESTIMONY WHEREOF, I have hereunto set my hand.

Assignor(s):

Name: Wei Ming

Signature: 

Date: 12/28/16

Name: Xiaonong Zhan

Signature: 

Date: 12/28/16

Name: Taisuke Akahori

Signature: \_\_\_\_\_

Date: \_\_\_\_\_



## ASSIGNMENT

WHEREAS I, the below named inventor (hereinafter referred to as Assignor(s)), have made an invention entitled:

### METHOD AND SYSTEM FOR CAPTURING IMAGES FOR WOUND ASSESSMENT WITH MOISTURE DETECTION

for which I executed an application for United States Letters Patent concurrently herewith; and

WHEREAS, KONICA MINOLTA LABORATORY U.S.A., INC., a corporation of California whose post office address is 2855 Campus Drive, Suite 100, San Mateo, California 94403, U.S.A. (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I, as Assignor, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my entire right, title, and interest in and to this invention, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, as well as all rights to claim priority on the basis of this application, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment and the Proprietary Rights and Confidentiality Agreement;

AND, I HEREBY covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment;

AND, I HEREBY further covenant and agree that I will cooperate with Assignee, its lawful successors and assigns, or, in case that the rights in this invention are further transferred from Assignee to an affiliate company, with the affiliate company in a manner consistent with existing and ongoing obligations under the Proprietary Rights and Confidentiality Agreement.

IN TESTIMONY WHEREOF, I have hereunto set my hand.

Assignor(s):

Name: Wei Ming Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Name: Xiaonong Zhan Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Name: Taisuke Akahori Signature: Taisuke Akahori Date: 12/26/2016